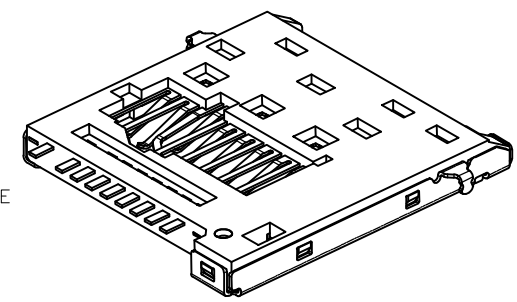
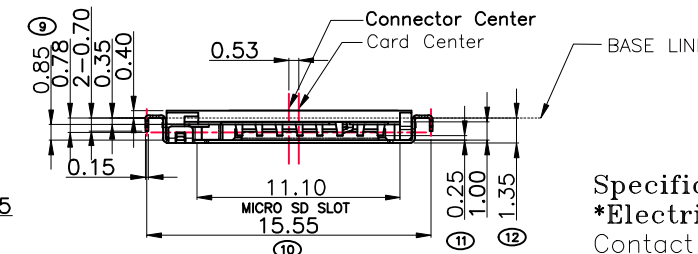
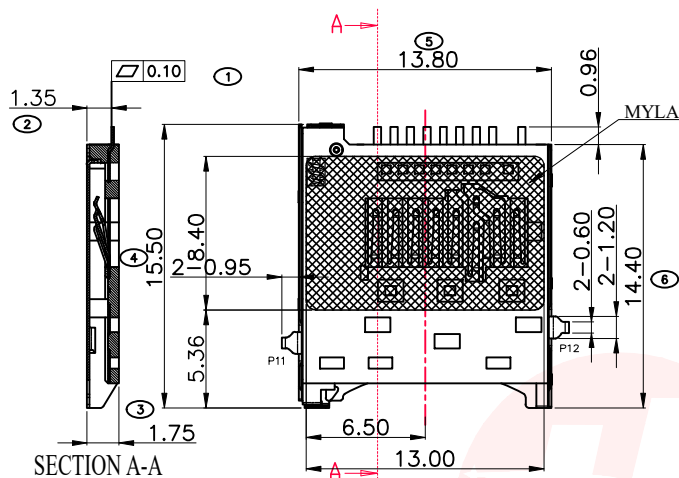




REV.	ECN NO OR DESCRIPTION	REVISED	DATE



**Specification**

**\*Electrical Characteristics:**

Contact Current Rating:0.5Amperes.  
 Dielectric Withstanding Voltage:AC500V r.m.s.  
 Insulation Resistance:1000 Megohms  
 Minimum At DC 500V.  
 Contact Resistance:100 mΩ Maximum.

**\*Mechanical Characteristics:**

Mating Cycles:10,000 Cycles.

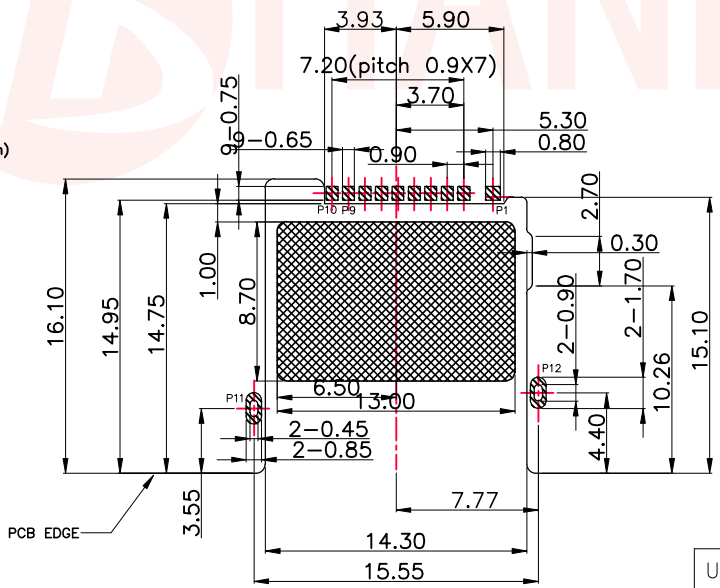
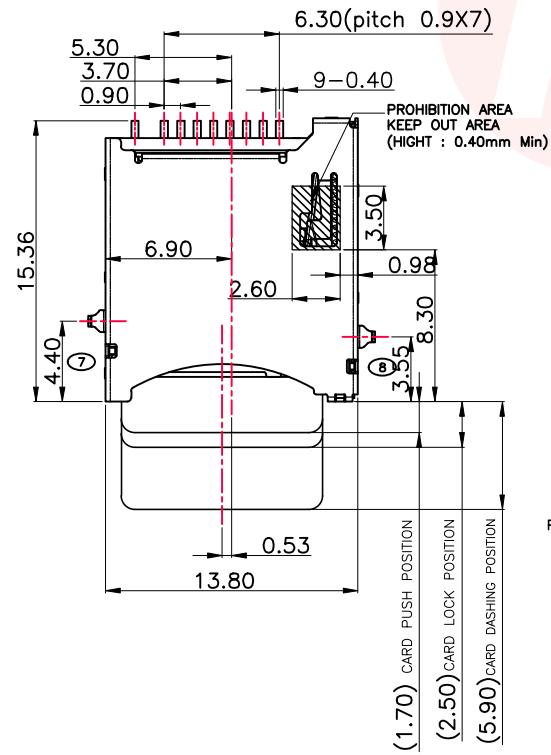
**\*Environmental:**

Operating Temperature:-25°C~+85°C.

**\*Materials:**

Insulator:HI-Temp plastic UL 94V-0 Rated.  
 Contact:Copper Alloy.  
 Shell:Stainless Steel(t=0.15mm).

Pin	Define
P1	SWITCH TERM CD
P2	DAT1
P3	DAT0
P4	VSS
P5	CLK
P6	VDD
P7	CMD
P8	CD/DAT3
P9	DAT2
P10	GND
P11	GND
P12	GND



■ PAD AREA    ▨ NO COPPER AREA

**PCB PATTERN LAYOUT**

(GENERAL TOLERANCE:±0.05)

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS:	ANGLES:
X    :±0.35	X    :±2°
X.X    :±0.25	X.X    :±1°
X.XX    :±0.10	



东莞市汉博电子科技有限公司  
 DONGGUAN HANBO TECHNOLOGY CO., LTD

TITLE	MICRO SD板下沉板1.35mm 主体加厚0.3			
DWN	xiong	PART NO. MR-1209		
CHKD	lee	SCALE:1:1	UNIT: mm	
APVD	wang	SIZE: A4	SHEET:10F 1	

CUSTOMER COPY